



**SPECIFICATION
FOR
LCD Module
KD018QVFMN010**

MODULE:	KD018QVFMN010
CUSTOMER:	

REV	DESCRIPTION	DATE
1.0	FIRST ISSUE	2017.03.13
1.1	Update the test specifications	2017.12.07
1.2	Update the drawing	2018.01.08

STARTEK	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		

Part. No	KD018QVFMN010	REV	V1.0	Page 1 of 28
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常备库存
Stock For Sale

长期供货
Long Time supply

支持小量
NO MOQ

品种齐全
In Full Range

[illegible]

Part. No	KD018QVFMN010	REV	V1.0	Page 2 of 28
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Contents

* Description	4
1. Block Diagram	5
2. Outline dimension	6
3. Input terminal Pin Assignment	7
4. LCD Optical Characteristics	9
4.1 Optical specification	9
4.2 Measuring Condition	9
4.3 Measuring Equipment	10
5. Electrical Characteristics	11
5.1 Absolute Maximum Rating (Ta=25 VSS=0V)	11
5.2 DC Electrical Characteristics	11
5.3 LED Backlight Characteristics	12
6. AC Characteristic	14
6.1 Display Parallel 8/16-bit Interface Timing Characteristics (8080 system)	14
6.2 Display Serial Interface Timing Characteristics (3-line SPI system)	16
6.3 Display Serial Interface Timing Characteristics (4-line SPI system)	17
6.4 Parallel RGB Interface Timing Characteristics	18
6.5 Reset Timing Characteristics	19
7. LCD Module Out-Going Quality Level	21
7.1 VISUAL & FUNCTION INSPECTION STANDARD	21
7.1.1 Inspection conditions	21
7.1.2 Definition	21
7.1.3 Sampling Plan	22
7.1.4 Criteria (Visual)	23
8. Reliability Test Result	25
8.1 Condition	25
9. Cautions and Handling Precautions	27
9.1 Handling and Operating the Module	27
9.2 Storage and Transportation	27
10. Packing	28

* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 1.77" TFT-LCD contains 240x320 pixels, and can display up to 65K colors.

* Features

-Low Input Voltage: VCC:3.3V(TYP);IOVCC:2.8-3.3V

-Display Colors of TFT LCD: 65K colors

-Interface: 8/9/16/18Bit MCU;

3/4SPI+16/18Bit RGB

3-line/4-line Serial Interface

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	26.64(H)*35.52(V) (1.77inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	65/262K	colors	-
Number of pixels	240(RGB)*320	dots	-
Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.111(H)*0.111(V)	mm	-
Viewing angle	Free	o'clock	-
Controller IC	ST7789V	-	-
Display mode	Transmissive/Normally black	-	-
Operating temperature	-20~+70	°C	-
Storage temperature	-30~+80	°C	-

* Mechanical Information

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)		34.7		mm	-
	Vertical(V)		46.7		mm	-
	Depth(D)		2.50		mm	-
Weight			TBD		g	-

Part. No	KD018QVFMN010	REV	V1.0	Page 4 of 28
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常备库存
Stock For Sale

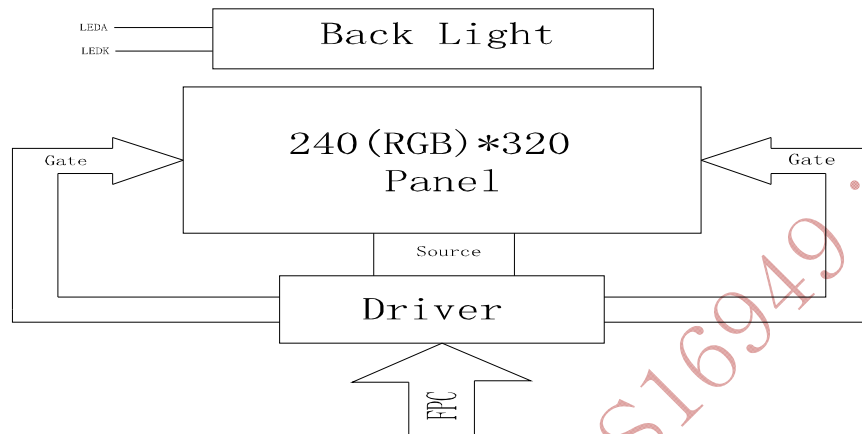
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1. Block Diagram



Part. No	KD018QVFMN010	REV	V1.0	Page 5 of 28
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3. Input terminal Pin Assignment

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	VCI/VCC	Supply voltage (3.3V).	P
3	IOVCC	Supply voltage (1.65-3.3V).	P
4	IM2	Interface selecting signal.	I
5	IM1		I
6	IM0		I
7	RESET	This signal will reset the device and must be applied to properly initialize the chip.	I
8	CS	Chip select input pin ("Low" enable). fix this pin at VCI or GND when not in use.	I
9	DC(SPI-SCL)	-Display data/command selection pin in parallel interface. -This pin is used to be serial interface clock. DC='1': display data or parameter. DC='0': command data. -If not used, please fix this pin at VDDI or DGND.	I
10	WR(SPI-RS)	-Write enable in MCU parallel interface. - Display data/command selection pin in 4-line serial interface. - Second Data lane in 2 data lane serial interface. -If not used, please fix this pin at VDDI or DGND.	I
11	RD	Serves as a read signal and MCU read data at the rising edge. fix this pin at VCI or GND when not in use.	I
12	VSNC	Frame synchronous signal. Low active. Connect to I GND when DPI is not selected.	I
13	HSNC	Line synchronous signal. Low active. Connect to GND when DPI is not selected.	I
14	ENABLE	Data enable signal in DPI operation. Low: Select (Accessible) High: Not select (Inaccessible) Connect to GND when DPI is not selected.	I
15	DOTCLK	Pixel clock signal. The data input timing is set on the rising edge.	I

Part. No	KD018QVFMN010	REV	V1.0	Page 7 of 28
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		Connect to GND when DPI is not selected.	
16	SDA	Serial data input/output pin in DBI Type C operation.	I
17~34	DB0~DB17	Data bus. Connect to GND when is not used.	P
35	SDO	This pin is enabled when SDOE=1 and DBI Type C is used. With this setting, SDA can be used as an input pin and SDO pin can be used as an output pin without bidirectional bus to execute serial communication. If not used please open.	O
36	LEDA	Anode pin of backlight.	P
37	LEDK1	Cathode pin of backlight.	P
38	LEDK2	Cathode pin of backlight.	P
39	LEDK3	Cathode pin of backlight.	P
40	NC	NC	
41	XR(NC)	Touch panel Right Glass Terminal	A/D
42	YU(NC)	Touch panel Top Film Terminal	A/D
43	XL(NC)	Touch panel LIFT Glass Terminal	A/D
44	YD(NC)	Touch panel Bottom Film Terminal	A/D
45	GND	Ground.	P

4. LCD Optical Characteristics

4.1 Optical specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio		CR	$\Theta=0$ Normal viewing angle	500	600		msec	
Response time	Rising	T _R		--	20	45		
	Falling	T _F		--	35	50		
Color gamut		S(%)		--	49.3	--	%	
Color Filter Chromaticity	White	W _X		0.280	0.320	0.360		
		W _Y		0.324	0.364	0.404		
	Red	R _X		0.579	0.599	0.619		
		R _Y		0.342	0.362	0.382		
	Green	G _X		0.324	0.344	0.364		
		G _Y		0.579	0.599	0.619		
	Blue	B _X		0.140	0.160	0.180		
		B _Y		0.098	0.118	0.138		
Viewing angle	Hor.	Θ_L	CR>10	60	85	--		
		Θ_R		60	85	--		
	Ver.	Θ_U		60	85	--		
		Θ_D		60	85	--		
		Option View Direction		Free				

4.2 Measuring Condition

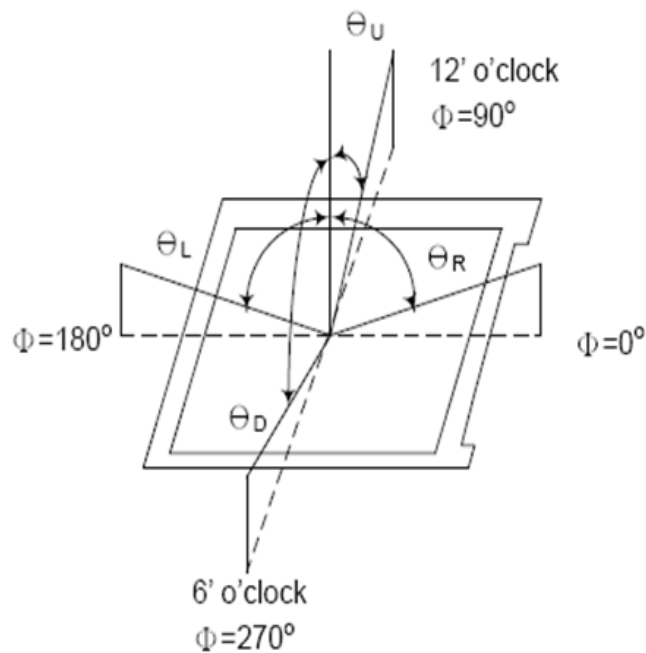
- Measuring surrounding: dark room
- Ambient temperature: $25\pm 2^\circ\text{C}$
- 15min. warm-up time.

Part. No	KD018QVFMN010	REV	V1.0	Page 9 of 28				
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4.3 Measuring Equipment

- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

Note (1) Definition of Viewing Angle:



Note (2) Definition of Contrast Ratio (CR) :
measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Part. No	KD018QVFMN010	REV	V1.0	Page 10 of 28
常 备 库 存 Stock For Sale		长 期 供 货 Long Time supply		支持小量 NO MOQ
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5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VDD	-0.3	4.6	V
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VDD	2.4	2.8	3.3	V	
Normal mode Current consumption	IDD	--	6.5	--	mA	
Level input voltage	V _{IH}	0.7V _{DDIO}		V _{DDIO}	V	
	V _{IL}	GND		0.3V _{DDIO}	V	
Level output voltage	V _{OH}	0.8V _{DDIO}		V _{DDIO}	V	
	V _{OL}	GND		0.2V _{DDIO}	V	

5.3 LED Backlight Characteristics

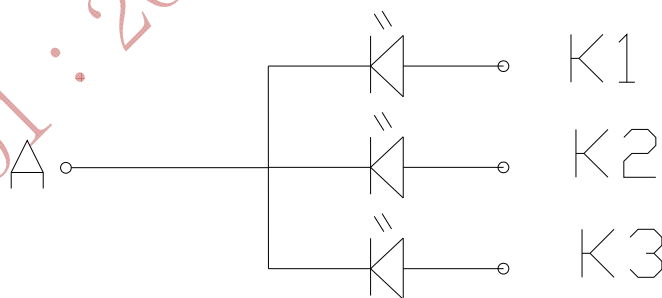
The back-light system is edge-lighting type with 3 chips White LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	45	60	--	mA	
Forward Voltage	V_F	--	3.2	--	V	
LCM Luminance	L_v	350	400	--	cd/m ²	Note3
LED life time	Hr	50000	--	--	Hour	Note1,2
Uniformity	AVg	80	--	--	%	Note3

Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition:

$T_a = 25 \pm 3^\circ \text{C}$, typical IL value indicated in the above table until the brightness becomes less than 50%.

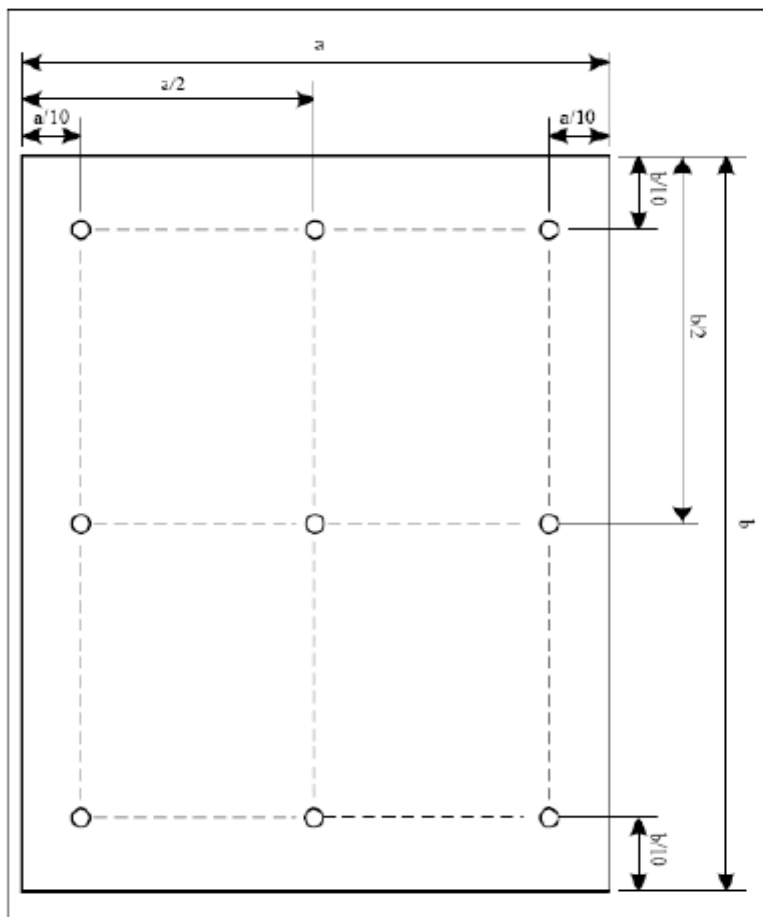
Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at $T_a = 25^\circ \text{C}$ and $I_L = 60 \text{mA}$. The LED lifetime could be decreased if operating I_L is larger than 60mA. The constant current driving method is suggested.



LED CIRCUIT DIAGRAM



NOTE 3: Luminance Uniformity of these 9 points is defined as below:



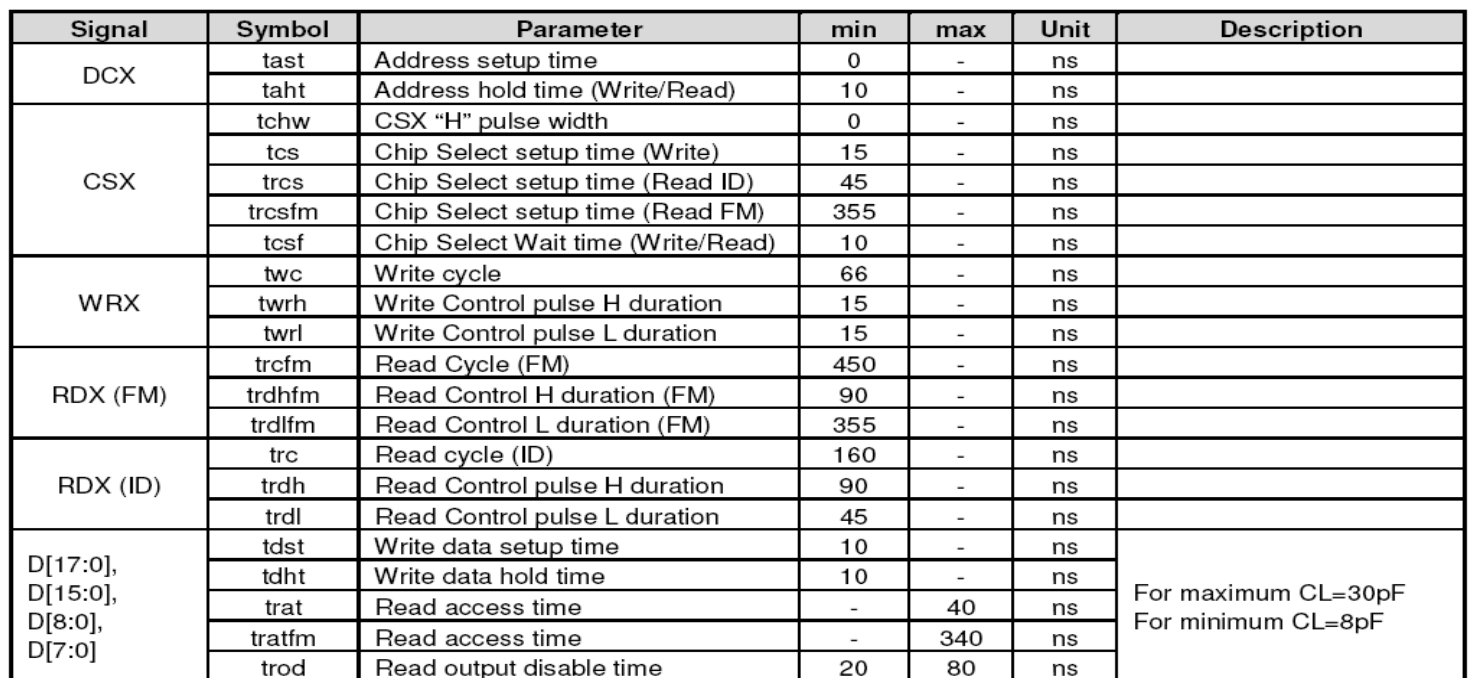
$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

Part. No	KD018QVFMN010	REV	V1.0	Page 13 of 28
常备库存 Stock For Sale		长期供货 Long Time supply		支持小量 NO MOQ
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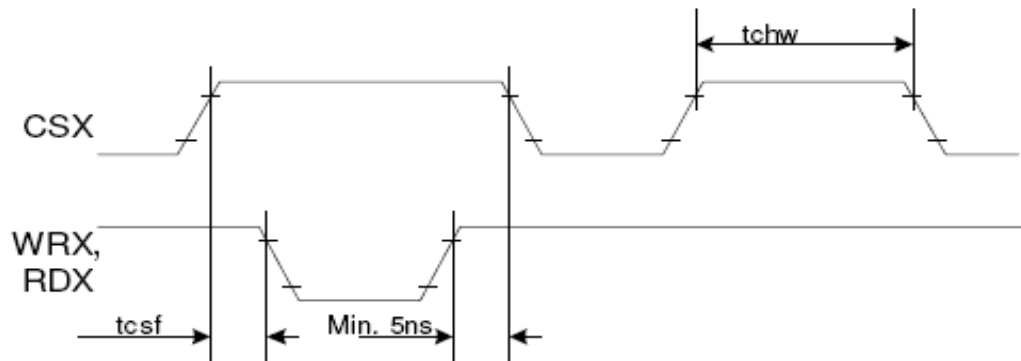
6.1 Display Parallel 8/16-bit Interface Timing Characteristics (8080 system)



Timing diagram for the proposed 1T1R1W scheme. The diagram shows a sequence of operations: Read (R), Write (W), Read (R), and Write (W). Each operation is represented by a horizontal bar with a rising and falling edge. The rising and falling times are labeled as $t_r \leq 15\text{ns}$. The data values are indicated by percentages: 70% and 30% for Read, and 30% and 70% for Write.

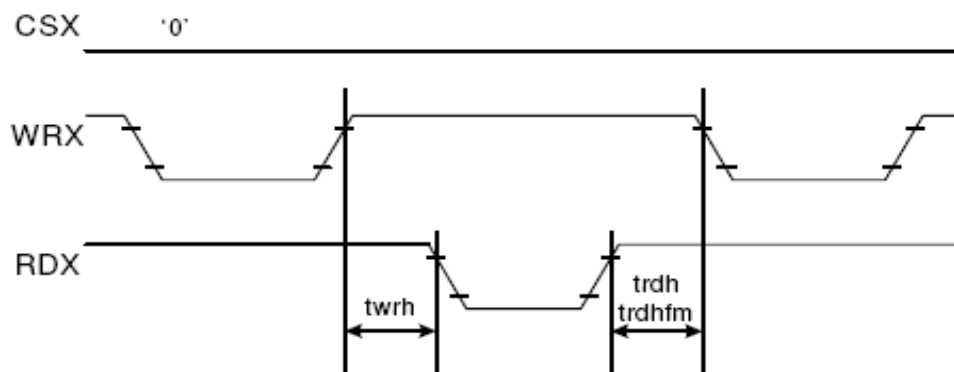
Part. No	KD018QVFMN010	REV	V1.0	Page 14 of 28
常 备 库 存 Stock For Sale		长 期 供 货 Long Time supply		支持小量 NO MOQ
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CSX timings :



Note: Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

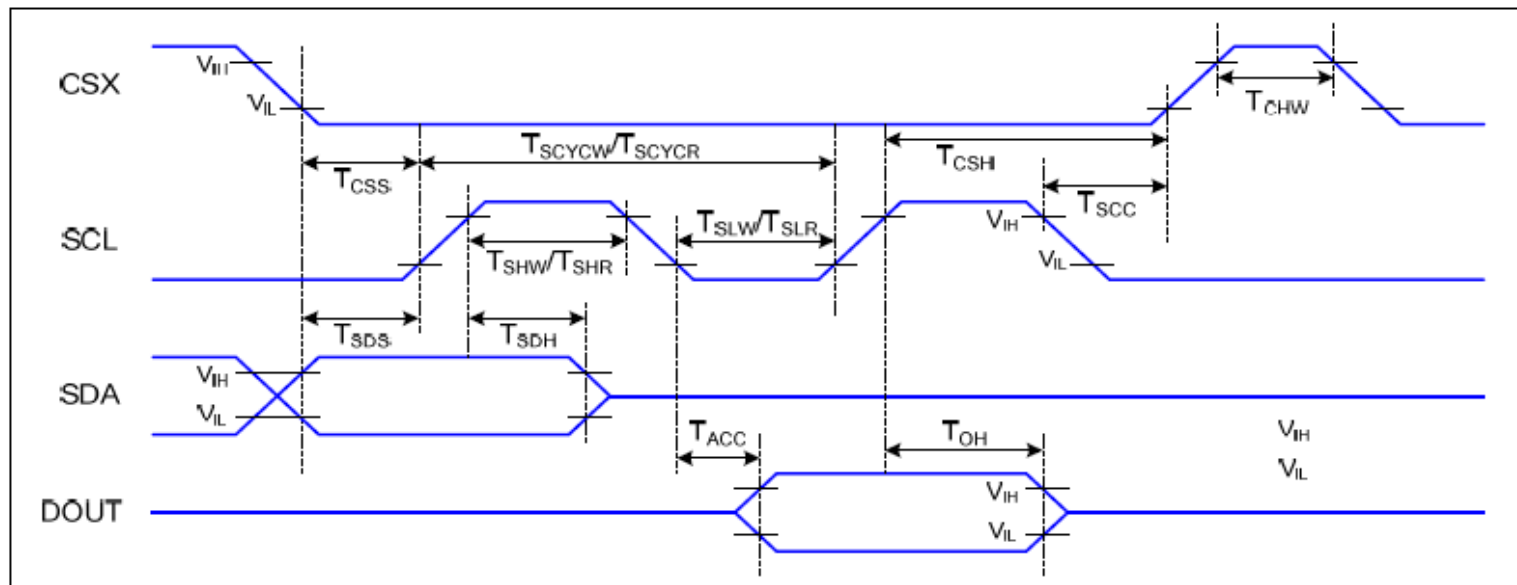
Write to read or read to write timings:



Note: Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

ISO9000

6.2 Display Serial Interface Timing Characteristics (3-line SPI system)



$V_{DD1}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=-30$ to $70^\circ C$

Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T _{CSS}	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SCC}	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select “H” pulse width	40		ns	
SCL	T _{SCYCW}	Serial clock cycle (Write)	66		ns	
	T _{SHW}	SCL “H” pulse width (Write)	15		ns	
	T _{SLW}	SCL “L” pulse width (Write)	15		ns	
	T _{SCYCR}	Serial clock cycle (Read)	150		ns	
	T _{SHR}	SCL “H” pulse width (Read)	60		ns	
	T _{SLR}	SCL “L” pulse width (Read)	60		ns	
SDA (DIN)	T _{SDS}	Data setup time	10		ns	
	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T _{OH}	Output disable time	15	50	ns	For minimum CL=8pF

Part. No	KD018QVFMN010	REV	V1.0	Page 16 of 28
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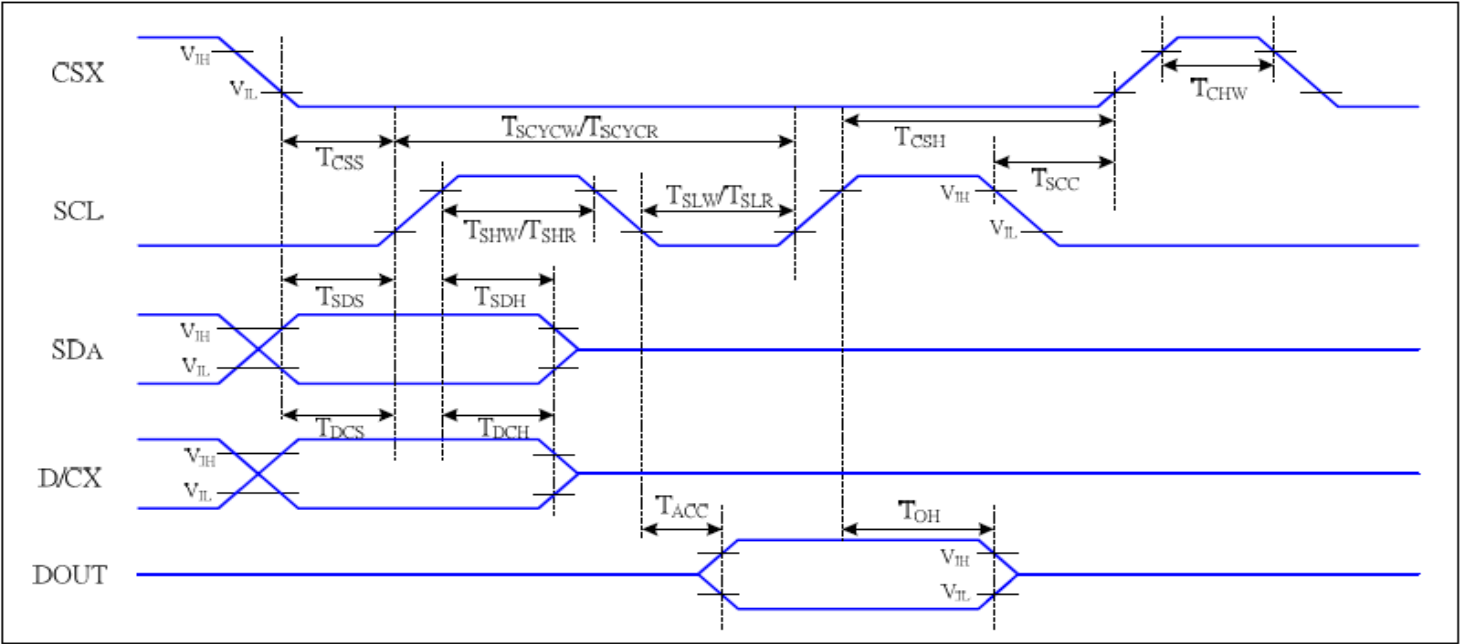
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支持小量
NO MOQ

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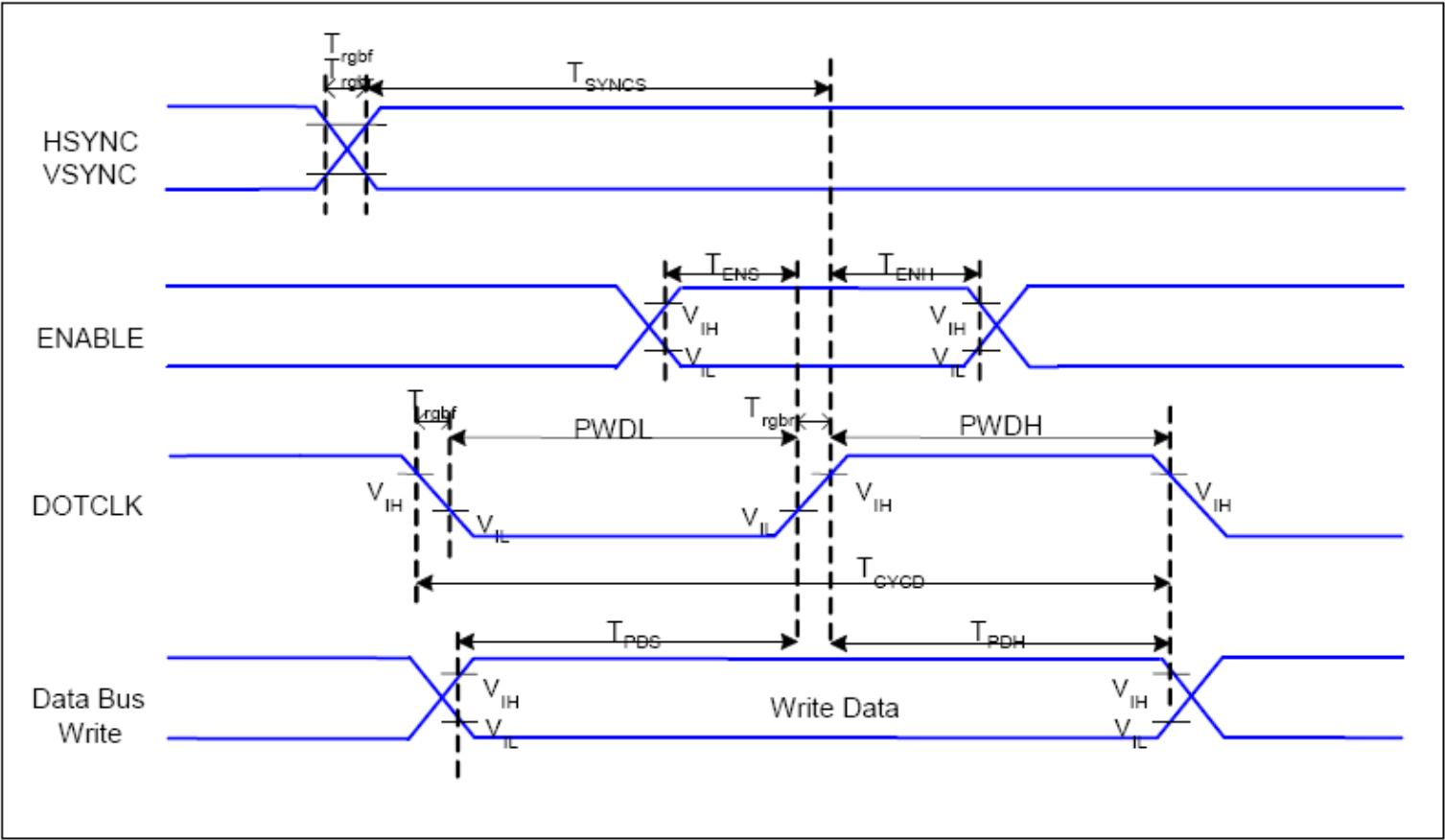
6.3Display Serial Interface Timing Characteristics (4-line SPI system)



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	T _{CSS}	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SCC}	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
SCL	T _{SCYCW}	Serial clock cycle (Write)	66		ns	-write command & data ram
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	
	T _{SLW}	SCL "L" pulse width (Write)	15		ns	
	T _{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
D/CX	T _{DCS}	D/CX setup time	10		ns	
	T _{DCH}	D/CX hold time	10		ns	
SDA (DIN)	T _{SDS}	Data setup time	10		ns	
	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T _{OH}	Output disable time	15	50	ns	For minimum CL=8pF

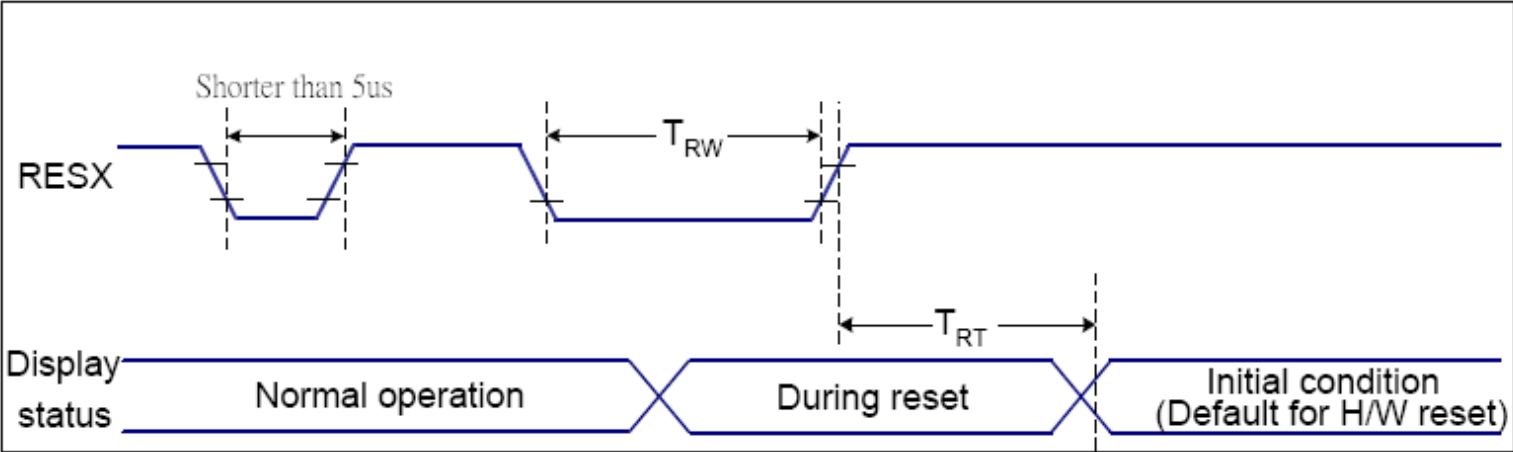
6.4 Parallel RGB Interface Timing Characteristics



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T_{SYNC}	VSYNC, HSYNC Setup Time	30	-	ns	
ENABLE	T_{ENS}	Enable Setup Time	25	-	ns	
	T_{ENH}	Enable Hold Time	25	-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	60	-	ns	
	T_{CycD}	DOTCLK Cycle Time	120	-	ns	
	T_{rghr}, T_{rghf}	DOTCLK Rise/Fall time	-	20	ns	
DB	T_{PDS}	PD Data Setup Time	50	-	ns	
	T_{PDH}	PD Data Hold Time	50	-	ns	

6.5 Reset Timing Characteristics



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 ℃

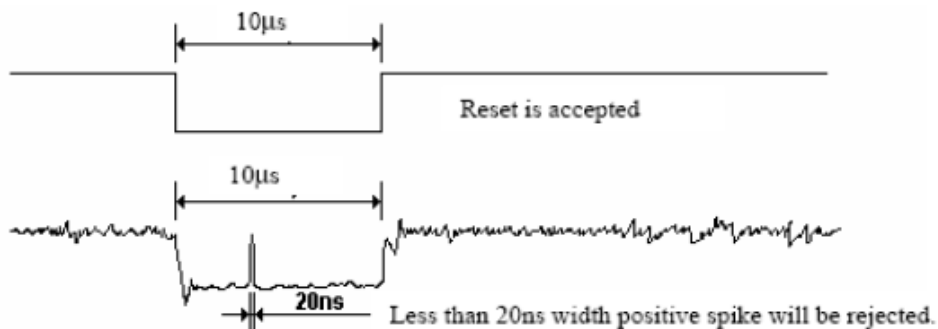
Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.

6. When Reset applied during Sleep Out Mode.

7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

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Part. No	KD018QVFMN010	REV	V1.0	Page 20 of 28
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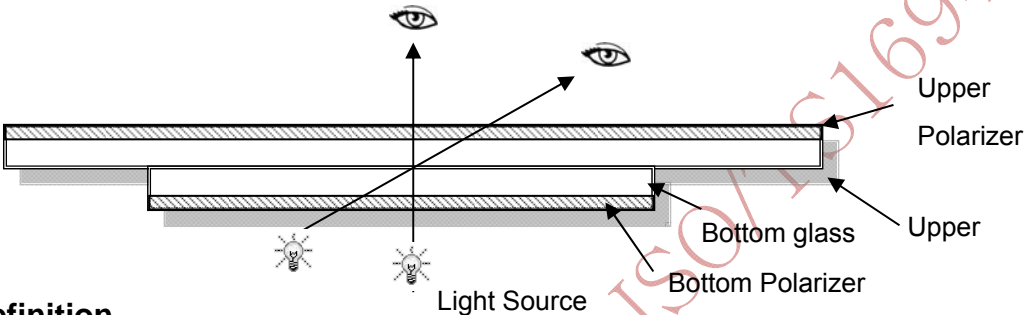
7. LCD Module Out-Going Quality Level

7.1 VISUAL & FUNCTION INSPECTION STANDARD

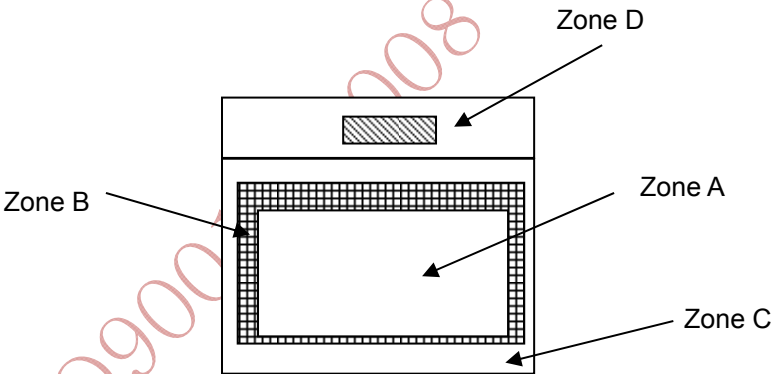
7.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

- Temperature : 25±5℃
- Humidity: 65%±10%RH
- Viewing Angle: Normal viewing Angle.
- Illumination: Single fluorescent lamp (300 to 700Lux)
- Viewing distance: 30-50cm



7.1.2 Definition



- Zone A: Effective Viewing Area (Character or Digit can be seen)
 - Zone B: Viewing Area except Zone A
 - Zone C: Outside (Zone A+Zone B) which can not be seen after assembly by customer.)
 - Zone D: IC Bonding Area
- Note: As a general rule, visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

Part. No	KD018QVFMN010	REV	V1.0	Page 21 of 28
常备库存 Stock For Sale		长期供货 Long Time supply		支持小量 NO MOQ
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7.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

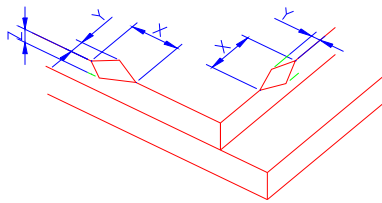
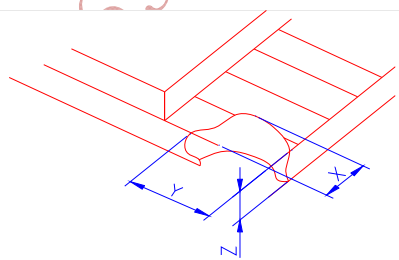
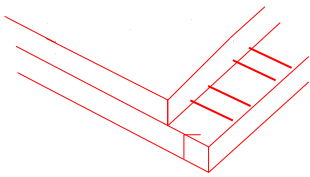
AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display, TP: Touch Panel, LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Soldering appearance	Good soldering , Peeling off is not allowed.	
6	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

7.1.4 Criteria (Visual)

Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken	 <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td><Inner border line of the seal</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
	X	Y	Z					
	≤3.0mm	<Inner border line of the seal	≤T					
(2)LCD corner broken	 <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td>≤L</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	≤L	≤T	
X	Y	Z						
≤3.0mm	≤L	≤T						
(3) LCD crack	 <p>Crack Not allowed</p>							



2.0

Spot defect

X

$\Phi=(X+Y)/2$

① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi\leq0.10$	Ignore		
$0.10<\Phi\leq0.20$	3(distance $\geq 10\text{mm}$)		
$0.20<\Phi\leq0.25$	2		
$\Phi>0.3$	0		

②Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spot)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi\leq0.1$	Ignore		
$0.10<\Phi\leq0.20$	3(distance $\geq 10\text{mm}$)		
$0.20<\Phi\leq0.25$	2		
$\Phi>0.3$	0		

③ Polarizer accidented spot

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi\leq0.2$	Ignore		
$0.3<\Phi\leq0.5$	2(distance $\geq 10\text{mm}$)		
$\Phi>0.5$	0		

④Pixel bad points (light dot, Dim dot, color dot)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi\leq0.1$	Ignore		
$0.15<\Phi\leq0.2$	2(distance $\geq 10\text{mm}$)		
$\Phi>0.2$	0		

⑤ Polarizer Bubble

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi\leq0.2$	Ignore		
$0.3<\Phi\leq0.4$	3(distance $\geq 10\text{ m}$)		
$0.4<\Phi\leq0.5$	2		
$\Phi>0.5$	0		

3.0	Line defect (LCD/TP /Polarizer backlight black/white line, scratch, stain)	Width(mm)	Length(mm)	Acceptable Qty		
				A	B	C
		$\Phi\leq0.03$	Ignore	Ignore		Ignore
		$0.03<W\leq0.04$	$L\leq3.0$	$N\leq2$		
		$0.04<W\leq0.05$	$L\leq2.0$	$N\leq1$		
		$0.05<W$	Define as spot defect			

4.0	Electronic Components SMT	Not allow missing parts, solderless connection, cold solder joint, mismatch, The positive and negative polarity opposite
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5.0	Display color& Brightness	1. Color: Measuring the color coordinates, The measurement standard according to the datasheet or samples. 2. Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.
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6.0	LCD Mura	By 5% ND filter invisible.
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Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

8. Reliability Test Result

8.1 Condition

Part. No	KD018QVFMN010	REV	V1.0	Page 25 of 28
常备库存 Stock For Sale		长期供货 Long Time supply		支持小量 NO MOQ
				品种齐全 In Full Range

Item	Condition	Inspection after test
High Temperature Operating	70℃, 96H	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1. Air bubble in the LCD; 2. Non-display; 3. Missing segments/line; 4. Glass crack; 5. Current IDD is twice higher than initial value.
Low Temperature Operating	-20℃, 96HR	
High Temperature Storage	80℃, 96HR	
Low Temperature Storage	-30℃, 96HR	
High Temperature & High Humidity Storage	+60℃, 90% RH, 96 hours.	
Thermal Shock (Non-operation)	-30℃, 30 min ↔ 80℃, 30 min, Change time: 5min 20CYC.	
ESD test	C=150pF, R=330, 5points/panel Air: ±8KV, 5times; Contact: ±6KV, 5 times; (Environment: 15℃~35℃, 30%~60%).	
Vibration (Non-operation)	Frequency range: 10~55Hz, Stroke: 1.5mm Sweep: 10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces, 80cm (MEDIUM BOX)	

Remark:

1. The test samples should be applied to only one test item.
2. Sample size for each test item is 5~10pcs.
3. For Damp Proof Test, Pure water (Resistance > 10MΩ) should be used.
4. In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
5. Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

Part. No	KD018QVFMN010	REV	V1.0	Page 26 of 28
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常备库存
Stock For Sale

长期供货
Long Time supply

支持小量
NO MOQ

品种齐全
In Full Range

9. Cautions and Handling Precautions

9.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

9.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

Part. No	KD018QVFMN010	REV	V1.0	Page 27 of 28
常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	



10. Packing

---TBD-----

ISO9001 : 2008 ISO/TS16949 : 2009

Part. No	KD018QVFMN010	REV	V1.0	Page 28 of 28
常 备 库 存 Stock For Sale		长 期 供 货 Long Time supply		支 持 小 量 NO MOQ
				品 种 齐 全 In Full Range